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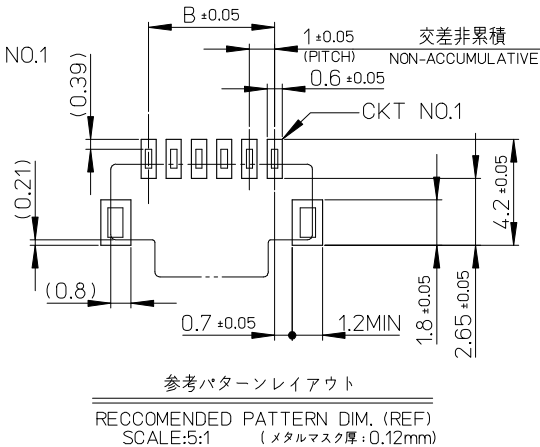
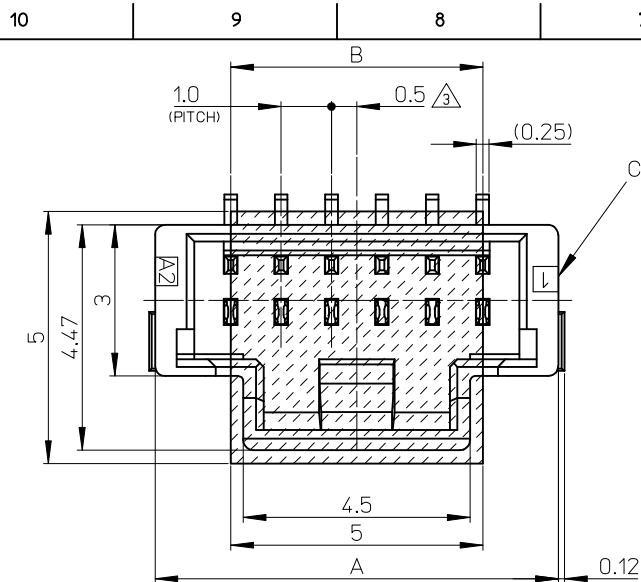
E

D

C

B

A



番号 NO.	部品 PART	材質 MATERIAL
①	ウエハー WAFER	ポリアミド UL94V-0 色: ナチュラル POLYAMIDE UL94V-0, COLOR: NATURAL
②	ソルダーピン SOLDER PIN	りん青銅 PHOSPHOR BRONZE 部分金メッキ: 0.1 μm MIN. SEPARATED GOLD PLATING ニッケルメッキ (下地): 1.0 μm MIN. NICKEL (UNDER PLATING)
③	ネイル NAIL	りん青銅 PHOSPHOR BRONZE 錫メッキ: 1.0 μm MIN. TIN ニッケルメッキ (下地): 1.0 μm MIN. NICKEL (UNDER PLATING)
④	カバーテープ COVER TAPE	ポリイミドテープ POLYIMIDE TAPE

※対応可能な極数は、別途お問い合わせ下さい。

14.0	17.0	504449-1507	15
13.0	16.0	504449-1407	14
12.0	15.0	504449-1307	13
11.0	14.0	504449-1207	12
10.0	13.0	504449-1107	11
9.0	12.0	504449-1007	10
8.0	11.0	504449-0907	9
7.0	10.0	504449-0807	8
6.0	9.0	504449-0707	7
5.0	8.0	504449-0607	6
B	A	EMBOSSED PACKAGE オーダー番号 ORDER NO.	極数 CKT.

NOTES.

- 嵌合相手: 501330-****
MATE WITH: 501330-****
- ソルダーピン及びネイル平坦度は、0.1 MAX.
SOLDER PIN AND NAIL COPLANARITY TO BE 0.1 MAX.
- 極数=偶数に適用
APPLY FOR CKT SIZE=EVEN
- 2~5極は、SD-504449-001を参照下さい。
REFER TO SD-504449-001 ABOUT 2-5CKT.
- ELV及びRoHS適合品。
ELV AND RoHS COMPLIANT.

RELEASED EC NO: J2012-1436 2012/12/13 DRWK:KASHIO 2012/12/14 CHKD:KASAKAWA 2012/12/21 APPR:Y01TO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION				
		10 UNDER	± 0.2	KWASHIO	2012/12/13	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW S/T) 6-15CKT						
		10 OVER 30 UNDER	± 0.25	CHECKED BY							DATE	
		30 OVER	± 0.3	APPROVED BY Y01TO		DATE 2012/12/21		DOCUMENT NO. molex SD-504449-002				
		ANGULAR ±3 °		MATERIAL NO.		SHEET NO. 1 OF 1						
	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

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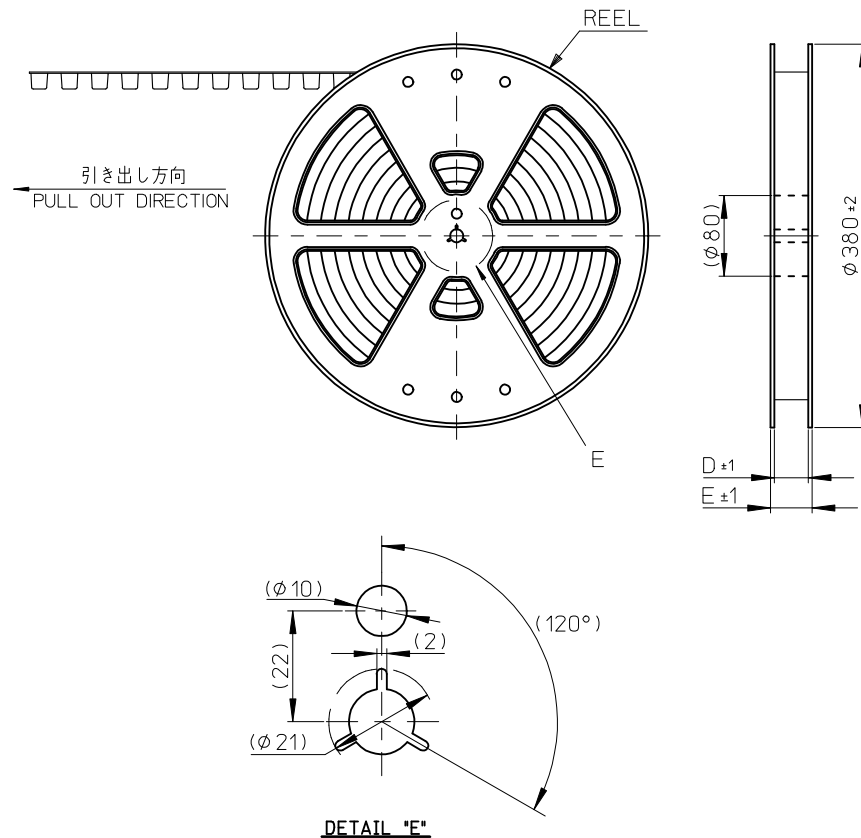
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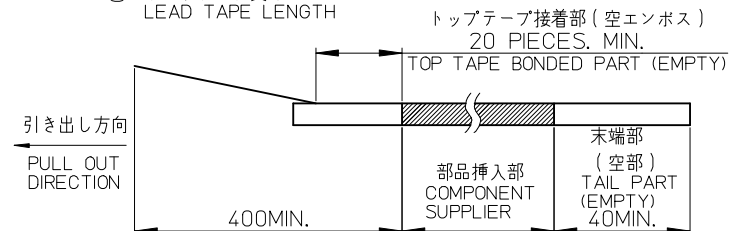
B

A



NOTES.

- 製品詳細寸法については製品単体図面を参照ください。
ABOUT DETAILED DIMENSION, SEE PRODUCT DRAWING.
- 梱包数量: 1100個/リール
NUMBER OF CONNECTORS: 1100PIECES/REEL
- リードテープ長さ
LEAD TAPE LENGTH



- 材料
MATERIAL
キャリアテープ: ポリプロピレン
CARRIER TAPE: POLYPROPYLENE
トップテープ: PET、PE、REF
TOP TAPE
リール: ポリスチレン (リサイクル材を含む)
REEL: POLYSTYRENE (RECYCLE MATERIAL CONTAINED)
- ELV 及び RoHS適合品
ELV AND RoHS COMPLIANT.

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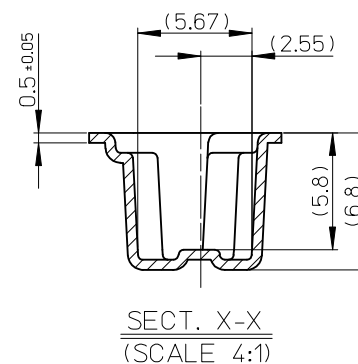
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RELEASED EC NO: J2012-1436 2012/12/13 DRWN:KASHIO 2012/12/14 CHKD:KASAKAWA 2012/12/21 APPR:YOITO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY KASHIO	DATE 2012/12/13	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW S/T) EMBSTP PKG				
		10 OVER 30 UNDER	± 0.25	CHECKED BY	DATE					
		30 OVER	± 0.3	APPROVED BY YOITO	DATE 2012/12/21	MATERIAL NO. SEE SHEET 2				
		ANGULAR ±1 °		DOCUMENT NO. SD-504449-004						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							
0	REV									



37.4	33.4	32	14.2	18.3	504449-1507	15
				17.3	504449-1407	14
				16.3	504449-1307	13
29.4	25.4	24	11.5	15.3	504449-1207	12
				14.3	504449-1107	11
				13.3	504449-1007	10
				12.3	504449-0907	9
				11.3	504449-0807	8
				10.3	504449-0707	7
				9.3	504449-0607	6
E	D	C	(B)	(A)	EMBOSSD PACKAGE	極数 CKT.
					オーダー番号 ORDER NO.	
CONNECTOR SERIES No. 504449-***9						

SEE SHEET1 EC NO: J2012-1436 DRAWN: KWASHIO CHKD: KASAKAWA APPR: YOITO 2012/12/13 2012/12/14 2012/12/21	DESCRIPTION GENERAL TOLERANCES (UNLESS SPECIFIED) 10 UNDER ± 0.2 10 OVER 30 UNDER ± 0.25 30 OVER ± 0.3 ANGULAR ± 1 ° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
		DRAWN BY KWASHIO	DATE 2012/12/13	TITLE 1.0 WIRE TO BOARD CONN. WAFER ASS'Y (1-ROW S/T) EMBSTP PKG		
		CHECKED BY YOITO	DATE 2012/12/21			
		APPROVED BY YOITO	DATE 2012/12/21	MOLEX INCORPORATED		
		MATERIAL NO. SEE TABLE		DOCUMENT NO. SD-504449-004	SHEET NO. 2 OF 2	
REV 0		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			